# CRMQBL0308A

#### P-Channel -30V, 7.4mΩ Typ. Power MOSFET

## **Description**

#### **Features**

• -30V, -40A

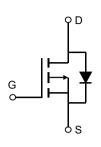
$$R_{DS(ON)}$$
 Typ = 7.4m $\Omega$  @  $V_{GS}$  = -10 $V$ 

$$R_{DS(ON)}$$
 Typ = 11m $\Omega$  @  $V_{GS}$  = -4.5 $V$ 

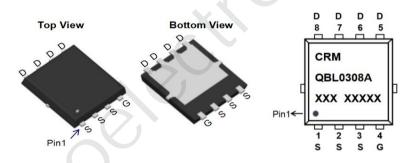
- Advanced Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- Lead Free
- 100% UIS TESTED!
- 100% ΔVds TESTED!

## **Application**

- Load Switch
- PWM Application
- Power Management







**Marking and Pin Assignment** 

#### **Package Marking and Ordering Information**

| Device      | Marking     | Package        | Outline | Reel Size | Reel (pcs) | Per Carton (pcs) |
|-------------|-------------|----------------|---------|-----------|------------|------------------|
| CRMQBL0308A | CRMQBL0308A | PDFN3.3x3.3-8L | TAPING  | 13"       | 5000       | 50000            |

## **Absolute Maximum Ratings** (@ $T_J = 25^{\circ}C$ unless otherwise specified)

| Symbol          | Parameter                            |                        | Value      | Units |
|-----------------|--------------------------------------|------------------------|------------|-------|
| $V_{DS}$        | Drain-to-Source Voltage              |                        | -30        | V     |
| $V_{GS}$        | Gate-to-Source Voltage               |                        | ±20        | V     |
|                 | Continuous Drain Current             | T <sub>C</sub> = 25°C  | -40        | А     |
| I <sub>D</sub>  | Continuous Drain Current             | T <sub>C</sub> = 100°C | -24        | А     |
| $I_{DM}$        | Pulsed Drain Current (1)             |                        | -160       | А     |
| E <sub>AS</sub> | Single Pulsed Avalanche Energy (2)   |                        | 56         | mJ    |
| $P_{D}$         | Power Dissipation                    | T <sub>C</sub> = 25°C  | 26         | W     |
| $R_{	hetaJC}$   | Thermal Resistance, Junction to Case |                        | 4.8        | °C/W  |
| $T_J,T_STG$     | Junction & Storage Temperature Range |                        | -55 to 150 | °C    |

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## **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

| Symbol               | Parameter  | Conditions   | Min.       | Тур. | Max. | Uni |
|----------------------|--|--|------------|------|------|-----|
| Off Chara            | acteristics                                      |  |            |      |      |     |
| V <sub>(BR)DSS</sub> | Drain-Source Breakdown Voltage                   | $I_D = -250 \mu A, V_{GS} = 0 V$                               | -30        | -    | -    | V   |
| I <sub>DSS</sub>     | Zero Gate Voltage Drain Current                  | $V_{DS} = -30V, V_{GS} = 0V$                                   | -          | -    | -1.0 | μΑ  |
| I <sub>GSS</sub>     | Gate-Body Leakage Current                        | $V_{DS} = 0V, V_{GS} = \pm 20V$                                | -          | -    | ±100 | nA  |
| On Chara             | acteristics                                      |  |            |      | 6    |     |
| $V_{GS(th)}$         | Gate Threshold Voltage                           | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$                          | -1.1       | -1.5 | -2.2 | V   |
| В                    | Static Drain-Source ON-Resistance <sup>(3)</sup> | $V_{GS} = -10V, I_D = -15A$                                    | -          | 7.4  | 9.6  | mΩ  |
| $R_{DS(ON)}$         | Static Drain-Source ON-Resistance                | $V_{GS} = -4.5V, I_D = -10A$                                   | -          | 11   | 14.3 | mΩ  |
| Dynamic              | Characteristics                                  |  |            |      |      |     |
| C <sub>iss</sub>     | Input Capacitance                                |  | <u>-</u> ( | 1390 | -    | pF  |
| $C_{oss}$            | Output Capacitance                               | $V_{GS} = 0V, V_{DS} = -15V,$<br>f = 1MHz                      | X - \      | 251  | -    | pF  |
| $C_{rss}$            | Reverse Transfer Capacitance                     | 1 - 1141112  |            | 217  | -    | pF  |
| $Q_g$                | Total Gate Charge                                |  | <u> </u>   | 25   | -    | nC  |
| $Q_gs$               | Gate Source Charge                               | $V_{GS} = 0 \text{ to } -10V$<br>$V_{DS} = -15V, I_{D} = -20A$ | -          | 4    | -    | nC  |
| $Q_{gd}$             | Gate Drain("Miller") Charge                      | V <sub>DS</sub> = -13V, 1 <sub>D</sub> = -20A                  | -          | 5.5  | -    | nC  |
| Switchin             | g Characteristics                                |  |            |      |      |     |
| t <sub>d(on)</sub>   | Turn-On DelayTime                                | .( )   | -          | 11   | -    | ns  |
| t <sub>r</sub>       | Turn-On Rise Time                                | $V_{GS} = -10V, V_{DD} = -15V$                                 | -          | 17   | -    | ns  |
| $t_{\text{d(off)}}$  | Turn-Off DelayTime                               | $I_D$ = -20A, $R_{GEN}$ = $3\Omega$                            | -          | 60   | -    | ns  |
| $t_f$                | Turn-Off Fall Time                               |  | -          | 45   | -    | ns  |
| Drain-So             | urce Diode Characteristics and M                 | lax Ratings  |            |      |      |     |
| I <sub>S</sub>       | Maximum Continuous Drain to Source Di            | ode Forward Current  | -          | -    | -40  | Α   |
| I <sub>SM</sub>      | Maximum Pulsed Drain to Source Diode             | Forward Current  | -          | -    | -160 | Α   |
| V <sub>SD</sub>      | Drain to Source Diode Forward Voltage            | V <sub>GS</sub> = 0V, I <sub>S</sub> = -15A                    | -          | -    | -1.2 | V   |
| trr                  | Body Diode Reverse Recovery Time                 | I - 20A di/dt - 400A/:   | -          | 15   | -    | ns  |
| Qrr                  | Body Diode Reverse Recovery Charge               | $I_F = -20A$ , di/dt = 100A/us                                 | -          | 6    | -    | nC  |

Notes:

<sup>1.</sup> Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

<sup>2.</sup>  $E_{AS}$  condition: Starting  $T_J$ =25°C,  $V_{DD}$ =-15V,  $V_G$ =-10V,  $R_G$ =25ohm, L=0.5mH,  $I_{AS}$ =-15A

<sup>3.</sup> Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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## **Test Circuit**

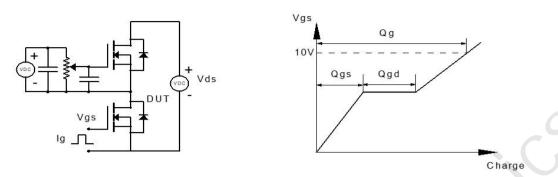


Figure 1: Gate Charge Test Circuit & Waveform

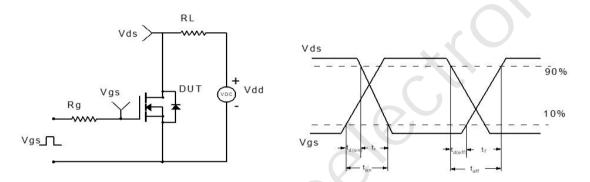


Figure 2: Resistive Switching Test Circuit & Waveform

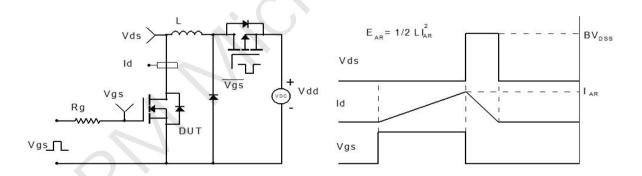


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

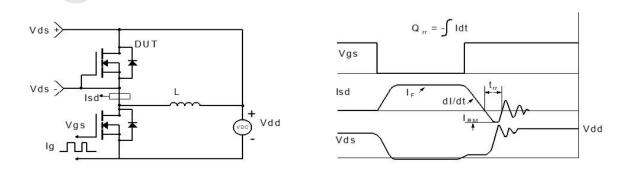
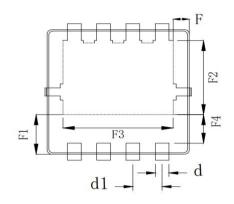


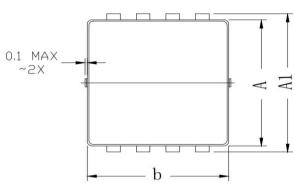
Figure 4: Diode Recovery Test Circuit & Waveform

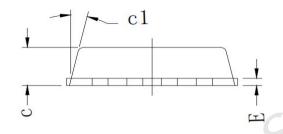
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## Package Mechanical Data(PDFN3.3x3.3-8L)







|        | COMMON DIM      | ENSION (MM) |        |  |
|--------|-----------------|-------------|--------|--|
| PKG    | PDFN 3.3×3.3-8L |             |        |  |
| SYMBOL | MIN             | TYP         | MAX    |  |
| A      | 3.070           | 3.100       | 3.130  |  |
| A1     | 3. 300          | 3.400       | 3.500  |  |
| b      | 3.070           | 3.100       | 3.130  |  |
| С      | 0.770           | 0.800       | 0.830  |  |
| c1     | _               | 13°         | 82     |  |
| d      | 0. 275          | 0.300       | 0. 325 |  |
| d1     | 0. 625          | 0.650       | 0.675  |  |
| E      | 0. 144          | 0. 152      | 0. 160 |  |
| F      | 0. 300          | 0. 325      | 0. 350 |  |
| F1     | 0. 960          | 0.985       | 1. 010 |  |
| F2     | 1, 775          | 1. 800      | 1.825  |  |
| F3     | 2. 425          | 2. 450      | 2. 475 |  |
| F4     | 0.660           | 0. 685      | 0.710  |  |
| F4     | 0.660           | 0. 685      |        |  |

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